



Docket No.: 059516-0052

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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|-----------------------------------|---|---------------------------|
| In re Application of | : | Customer Number: 20277 |
| Zi-Kui LIU, et al. | : | Confirmation Number: 1022 |
| Application No.: 10/784,899 | : | Group Art Unit: 1762 |
| Filed: February 24, 2004 | : | Examiner: Brian K. Talbot |
| For: BORIDE THIN FILMS ON SILICON | : | |

PETITION FOR EXTENSION OF TIME

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

It is respectfully requested that the time for response to the Office Action dated February 17, 2005, now due to expire May 17, 2005, be extended for one month(s) and set to expire on June 17, 2005.

Please charge the extension fee of \$60.00 to Deposit Account No. 500417. Please charge any additional fees or credit any overpayment to Deposit Account No. 500417.

06/20/2005 SZEWDIE1 00000131 500417 10784899

01 FC:2251 60.00 DA

Respectfully submitted,

McDERMOTT WILL & EMERY LLP

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Date: June 17, 2005

**Please recognize our Customer No. 20277
as our correspondence address.**